

Docket No.: 259189US40PCT



COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

ATTORNEYS AT LAW

RE: Application Serial No.: 10/509,899

Applicants: Motoo ASAI, et al.

Filing Date: June 29, 2005

For: SUBSTRATE FOR MOUNTING IC CHIP, MANUFACTURING
METHOD OF SUBSTRATE FOR MOUNTING IC CHIP, DEVICE
FOR OPTICAL COMMUNICATION, AND MANUFACTURING
METHOD OF DEVICE FOR OPTICAL COMMUNICATION

Group Art Unit: 2814

Examiner: JAHAN, BILKIS

SIR:

Attached hereto for filing are the following papers:

Request for Reconsideration

Credit card payment is being made online (if electronically filed), or is attached hereto (if paper filed), in the amount of **\$0.00** to cover any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R. 1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. **15-0030**. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. 1.136 for the necessary extension of time.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.



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